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Application Data Sheet 37 CFR			Attorney Do		ey Dock	et N	umber	per MIYOSH0006					
			Application Number										
Title of Inv	.DING M.	NG MATERIAL FOR SEALING AND ELECTRONIC COMPONENT											
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Residen	ce Inform	ation (Selec	t One)	Us	Residence	су 🧿) No	n US Res	sidency	○ Active	US Military Serv	rice	
City Ts	ukuba-shi,	Ibaraki		Count	ry Of Re	esidend	cei	JP					
Citizenship under 37 CFR 1.41(b)			JP	JP									
Mailing A	ddress o	f Applicant:											_
Address	1	c/o Hit	achi Che	emical Co	o., Ltd.,								
Address	2	Resea	rch & De	evelopme	ent Cente	r, 48 Wa	adai						_
City	Tsukub	a-shi, Ibaraki			State/Province				ice				_
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Mailing Address of Applicant:													
Address 1 c/o Hitachi Chemical Co., Ltd.,							_						
					elopment Center, 48 Wadai							_	
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Application Data S	heet 37 CFR 1 76	Attorney Dock	Attorney Docket Number		MIYOSH0006				
Application Data 3	neer 37 Cr R 1.70	Application Number							
Title of Invention EPC	XY RESIN MOLDING I	MATERIAL FOR SE	EALING AND E	ELECTRONI	C COMPONE	NT			
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Application Inform	nation:								
Title of the Invention	EPOXY RESIN MO	EPOXY RESIN MOLDING MATERIAL FOR SEALING AND ELECTRONIC COMPONENT							
Attorney Docket Numb	er MIYOSH0006		Small Ent	ity Status	Claimed []			
Application Type	Nonprovisional								
Subject Matter	Utility								
Suggested Class (if an	y)		Sub Class	s (if any)					
Suggested Technology	Center (if any)		L	L					
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Prior Application Statu	ıs				Re	move			
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Application Data Sheet 37 CFR 1.76

Attorney Docket Number

Application Number

Title of Invention

MIYOSH0006

EPOXY RESIN MOLDING MATERIAL FOR SEALING AND ELECTRONIC COMPONENT

This section allows for the applicant to claim benefit of foreign priority and to identify any prior foreign application for which priority is not claimed. Providing this information in the application data sheet constitutes the claim for priority as required by 35 U.S.C. 119(b) and 37 CFR 1.55(a). Remove **Application Number** Country i Parent Filing Date (YYYY-MM-DD) **Priority Claimed** 2003-413229 JΡ 2003-12-11 Yes O No Remove Country i Parent Filing Date (YYYY-MM-DD) **Application Number Priority Claimed** 2004-260963 JΡ Yes ○ No Additional Foreign Priority Data may be generated within this form by selecting the

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A signature of the applicant or representative is required in accordance with 37 CFR 1.33 and 10.18. Please see 37 CFR 1.4(d) for the form of the signature.						
Signature	/Joerg-Uwe Szipl/			Date (YYYY-MM-DD)	2006-06-12	
First Name	Joerg-Uwe	Last Name	Szipl	Registration Number	31799	

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Application Da	nta Sheet 37 CFR 1.76	Attorney Docket Number	MIYOSH0006		
Application be	nta officer of of it 1.70	Application Number			
Title of Invention	EPOXY RESIN MOLDING M.	DING MATERIAL FOR SEALING AND ELECTRONIC COMPONENT			

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